

Low Power DC/DC Boost Converter

UM1666S SOT23-5

UM1666DA DFN6L 2.0×2.0

General Description

The UM1666 is a PFM controlled step-up DC-DC converter with a switching frequency up to 1MHz. The device is ideal to generate output voltage for small to medium LCD bias supplies and white LED backlight supplies from a single cell Li-Ion battery. The part can also be used to generate standard 3.3V/5V to 12V power conversions.

With a high switching frequency of 1MHz, a low profile and small board area solution can be achieved using a chip coil and an ultra small ceramic output capacitor. The UM1666 has an internal 600mA switch current limit, offering lower output voltage ripple. The low quiescent current (typically 36µA) together with an optimized control scheme, allows device operation at very high efficiencies over the entire load current range.

Applications

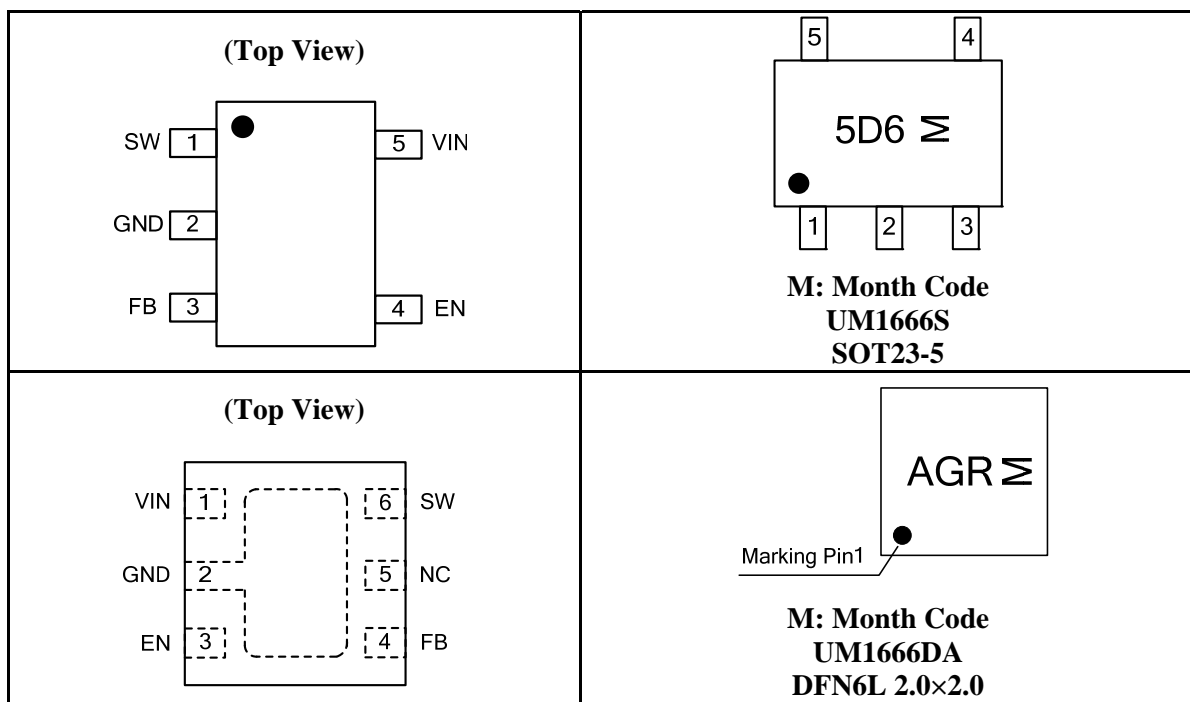
- LCD Bias Supply
- White LED Supply for LCD Backlights
- Digital Still Camera
- PDAs, Organizers and Handheld PCs
- Cellular Phones
- Standard 3.3V/5V to 12V Conversion

Features

- 2.0V to 6.0V Input Voltage Range
- Adjustable Output Voltage up to 28V
- 600mA Internal Switch Current
- Up to 1MHz Switching Frequency
- 36µA Typical No Load Quiescent Current
- 1µA Maximum Shutdown Current
- Internal Soft-Start
- Available in Tiny SOT23-5 and DFN6L 2.0×2.0 Packages

Pin Configurations

Top view



Ordering Information

Part Number	Packaging Type	Marking Code	Shipping Qty
UM1666S	SOT23-5	5D6	3000pcs/7Inch Tape & Reel
UM1666DA	DFN6L 2.0×2.0	AGR	3000pcs/7Inch Tape & Reel

Pin Description

Pin Number		Symbol	Function
UM1666S	UM1666DA		
1	6	SW	Connect the inductor and the Schottky diode to this pin. This is the switch pin and is connected to the drain of the internal power MOSFET.
2	2	GND	Ground
3	4	FB	This is the feedback pin of the device. Connect this pin to the external voltage divider to program the desired output voltage.
4	3	EN	This is the enable pin of the device. Pulling this pin to ground forces the device into shutdown mode reducing the supply current to less than 1μA. This pin should not be left floating and needs to be terminated.
5	1	VIN	Supply voltage pin
-	5	NC	Not connected

Absolute Maximum Ratings

Over operating free-air temperature (unless otherwise noted) (Note 1)

Symbol	Parameter	Value	Unit
V _{IN}	Supply Voltage on VIN (Note 2)	-0.3 to +7.0	V
V _{FB} , V _{EN}	Voltages on FB, EN (Note 2)	-0.3 to V _{IN} +0.3	V
V _{SW}	Switch Voltage on SW (Note 2)	30	V
P _D	Continuous Power Dissipation at T _A =25°C	SOT23-5	0.89
		DFN6L 2.0×2.0	1.56
T _J	Operating Junction Temperature	-40 to +150	°C
T _{STG}	Storage Temperature Range	-65 to +150	°C
T _L	Maximum Lead Temperature for Soldering 10 Seconds	+260	°C

Note 1: Stresses beyond those listed under absolute maximum ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under recommended operating conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

Note 2: All voltage values are with respect to network ground terminal.

Recommended Operating Conditions

Symbol	Parameter	Min	Typ	Max	Unit
V _{IN}	Input Voltage Range	2.0		6.0	V
V _{OUT}	Output Voltage Range			28	V
L	Inductor (Note 3)	1	10	22	μH
f	Switching Frequency (Note 3)			1	MHz
C _{IN}	Input Capacitor (Note 3)		10		μF
C _{OUT}	Output Capacitor (Note 3)	2.2	4.7		μF
T _A	Operating Ambient Temperature	-40		85	°C
T _J	Operating Junction Temperature	-40		125	°C

Note 3: Refer to application section for further information.

Function Block Diagram

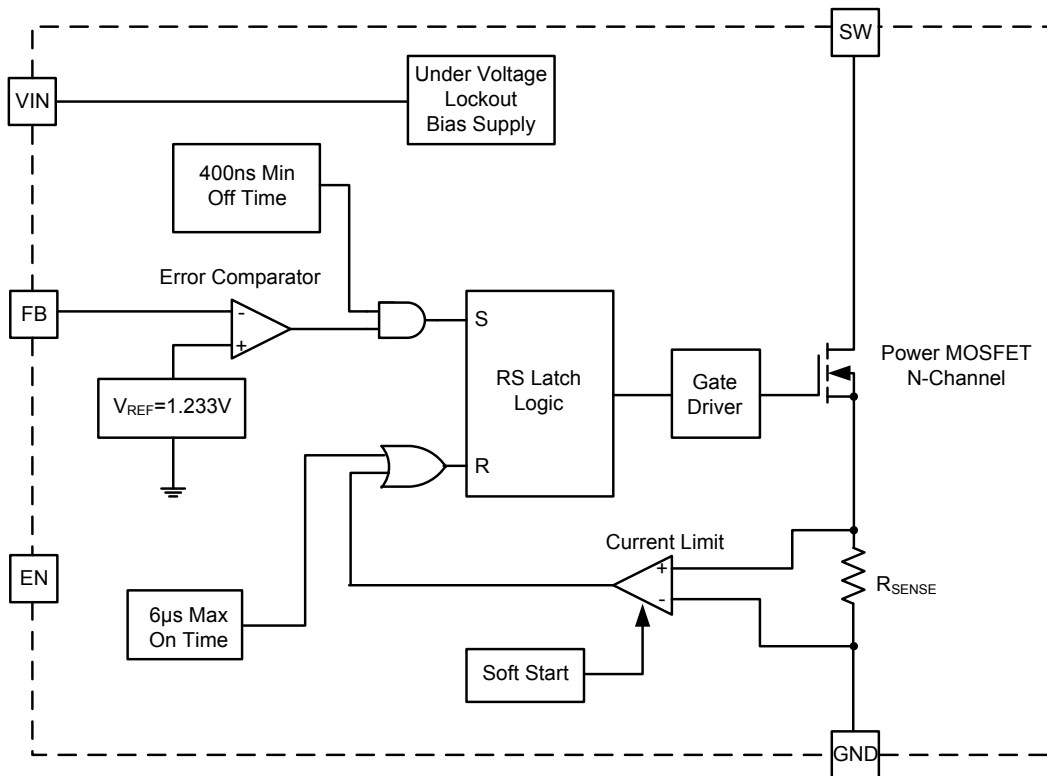


Figure 1. UM1666 Function Block Diagram

Electrical Characteristics

($V_{IN}=2.4V$, $EN=V_{IN}$, $C_{IN}=10\mu F$, $C_{OUT}=4.7\mu F$, $L=10\mu H$, $T_A=-40^{\circ}C$ to $85^{\circ}C$, typical values are at $T_A=25^{\circ}C$, unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
SUPPLY CURRENT						
V_{IN}	Input Voltage Range		2.0		6.0	V
I_Q	Operating Quiescent Current	$I_{OUT}=0mA$, not switching $V_{FB}=1.3V$		36	70	μA
I_{SD}	Shutdown Current	$EN=GND$		0.1	1	μA
V_{UVLO}	Under-Voltage Lockout Threshold			1.5	1.8	V
ENABLE						
V_{IH}	EN High Level Input Voltage		1.3			V
V_{IL}	EN Low Level Input Voltage				0.4	V
I_L	EN Input Leakage Current	$EN=GND$ or V_{IN}		0.1	1	μA
POWER SWITCH AND CURRENT LIMIT						
V_{SW}	Maximum Switch Voltage				28	V
t_{ON}	Maximum On Time		4	6	7.5	μs
t_{OFF}	Minimum Off Time		250	400	550	ns
$R_{DS(ON)}$	MOSFET On Resistance	$V_{IN}=2.4V$, $I_{SW}=50mA$		650	1000	$m\Omega$
	MOSFET Leakage Current	$V_{SW}=28V$		1	10	μA
I_{LIM}	MOSFET Current Limit			600		mA
OUTPUT						
V_{OUT}	Adjustable Output Voltage Range		V_{IN}		28	V
V_{REF}	Internal Voltage Reference			1.233		V
I_{FB}	Feedback Input Bias Current	$V_{FB}=1.3V$			1	μA
V_{FB}	Feedback Trip Point Voltage	$2.0V \leq V_{IN} \leq 6.0V$	1.196	1.233	1.270	V
	Line Regulation (Note 4)	$2.0V \leq V_{IN} \leq 6.0V$; $V_{OUT}=18V$; $I_{LOAD}=10mA$		0.5		%/V
	Load Regulation (Note 4)	$V_{IN}=2.4V$; $V_{OUT}=18V$; $0mA < I_{OUT} < 25mA$		0.15		%/mA

Note 4: The line and load regulation depend on the external component selection.

Operation

The UM1666 features a constant off-time control scheme. Operation can be best understood by referring to the function block diagram. The converter monitors the output voltage, and as soon as the feedback voltage falls below the reference voltage of typically 1.233V, the internal switch turns on and the current ramps up. The switch turns off as soon as the inductor current reaches the internally set peak current of typically 600mA. The second criteria that turns off the switch is the maximum on-time of 6 μ s (typical). This is just to limit the maximum on-time of the converter to cover for extreme conditions. As the switch is turned off the external Schottky diode is forward biased delivering the current to the output. The switch remains off for a minimum of 400ns (typical), or until the feedback voltage drops below the reference voltage again. Using this PFM peak current control scheme the converter operates in discontinuous conduction mode (DCM) where the switching frequency depends on the output current, which results in very high efficiency over the entire load current range.

Peak Current Control

The internal switch turns on until the inductor current reaches the typical dc current limit (I_{LIM}) of 600mA. There is approximately a 100ns delay from the time the current limit is reached and when the internal logic actually turns off the switch. During this 100ns delay, the peak inductor current will increase. This increase demands a larger saturation current rating for the inductor. This saturation current can be approximated by the following equation:

$$I_{\text{peak(typ)}} = I_{LIM} + \frac{V_{IN}}{L} \times 100\text{ns}$$

The higher the input voltage and the lower the inductor value are, the greater the peak current will be.

Soft-Start

All inductive step-up converters exhibit high inrush current during start-up if no special precaution is made. This can cause voltage drops at the input rail during start up and may result in an unwanted or early system shut down. The UM1666 limits this inrush current by increasing the current limit in two steps from $I_{LIM}/4$ for 256 cycles to $I_{LIM}/2$ for the next 256 cycles, and then full current limit.

Enable

Pulling the enable pin (EN) to ground shuts down the device reducing the shutdown current to 1 μ A (typical). Since there is a conductive path from the input to the output through the inductor and Schottky diode, the output voltage is equal to the input voltage during shutdown. The enable pin needs to be terminated and should not be left floating. Using a small external transistor disconnects the input from the output during shutdown as shown in the figure below.

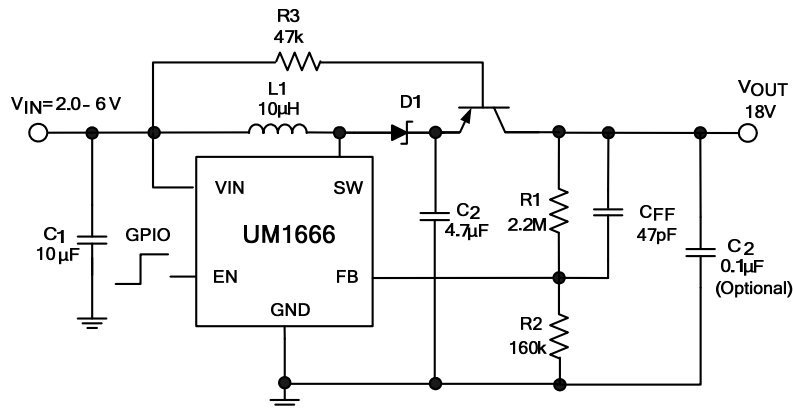


Figure 2. Disconnect the Input from the Output during Shutdown Using External Transistor

Under-Voltage Lockout

An under-voltage lockout prevents misoperation of the device at input voltages below typical 1.5V. When the input voltage is below the under-voltage threshold the main switch is turned off.

Typical Application Circuit

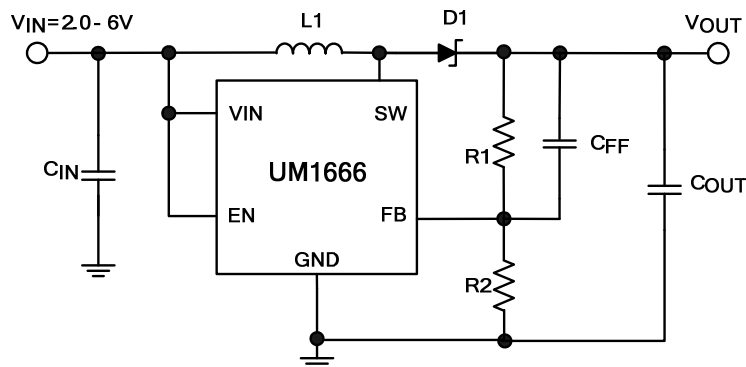


Figure 3. Standard DC/DC Boost Supply

The output voltage is calculated as:

$$V_{OUT} = 1.233 \times \left(1 + \frac{R1}{R2}\right)$$

Recommend Selection Table

V _{OUT} (V)	C _{IN} (µF)	C _{OUT} (µF)	C _{FF} (pF)	L (µH)
5	10	10	100	2.2
12	10	4.7	47	4.7
18	10	4.7	47	10
28	10	2.2	22	22

We can use a PWM signal on the enable pin of UM1666 to adjust the white LED brightness (see figure 4 below). When adding the PWM signal to EN pin, the UM1666 is turned on or off by the PWM signal, so the LEDs operate at either zero or full current. The average LED current increases proportionally with the duty cycle of the PWM signal. The magnitude of the PWM signal should be higher than the minimum enable voltage of EN pin (1.3V) and lower than the V_{IN} , in order to let the dimming control perform correctly. The frequency range of the PWM signal is from 50Hz to 10 kHz.

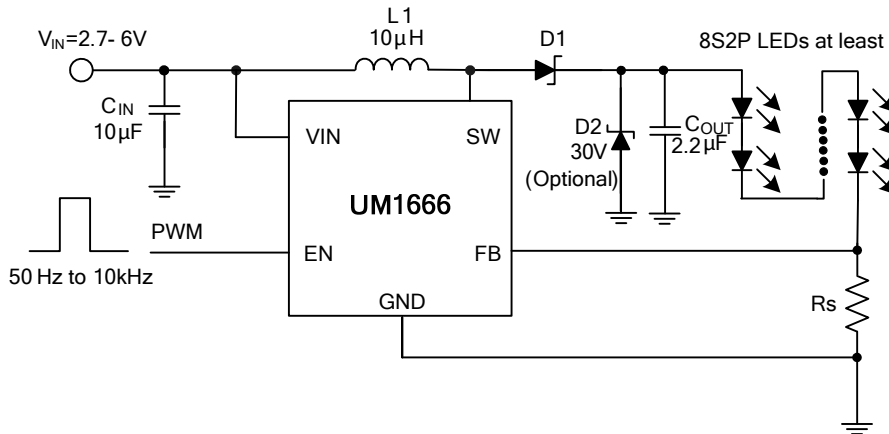
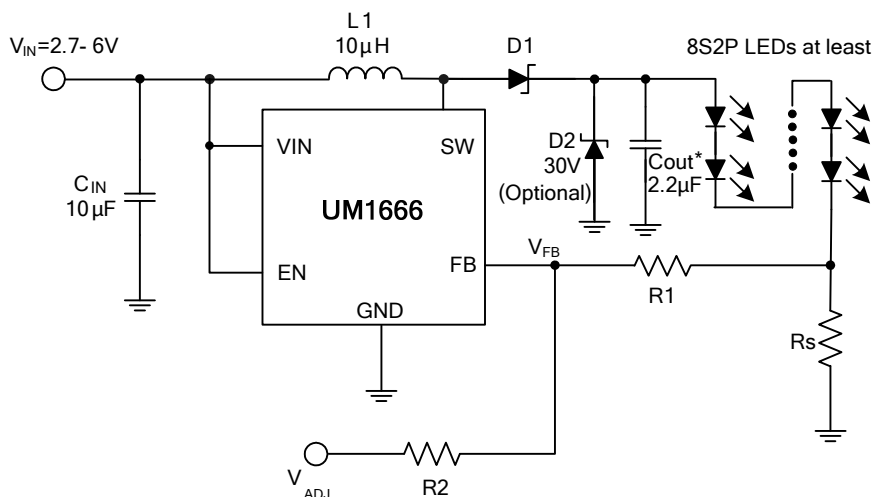


Figure 4.
White LED Supply with Adjustable Brightness Control
Using a PWM Signal on the Enable Pin

We also can adjust the white LED brightness using an analog signal on the feedback pin (see figure 5 below). Add a DC voltage to the FB pin, and adjust the LED current by change the DC voltage, which control the brightness. The LED current is calculated as:

$$I_{RS} = \frac{V_{FB} \times (R_1 + R_2) - V_{ADJ} \times R_1}{R_S \times R_2}$$

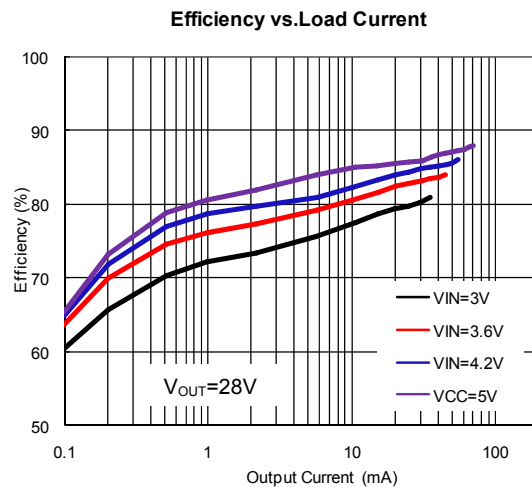
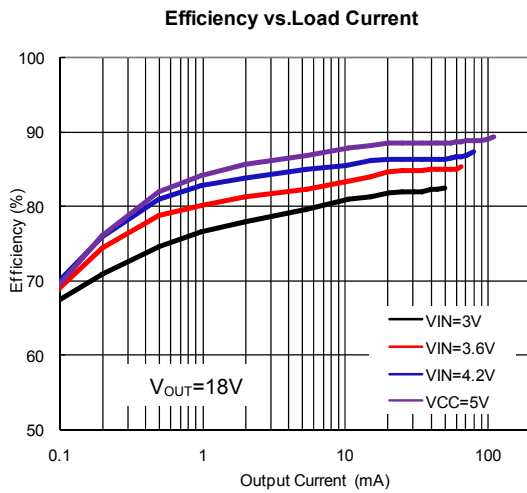
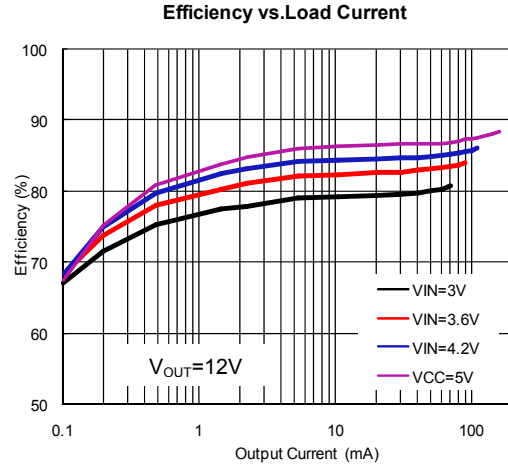
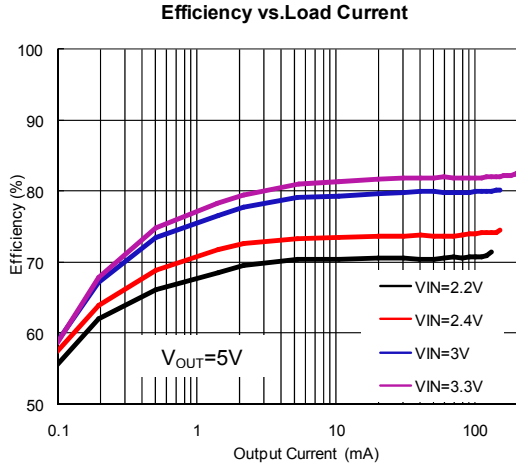


*A smaller output capacitor value for C_{out} causes a larger LED ripple

Figure 5.
White LED Supply with Adjustable Brightness Control Using an Analog Signal on the
Feedback Pin

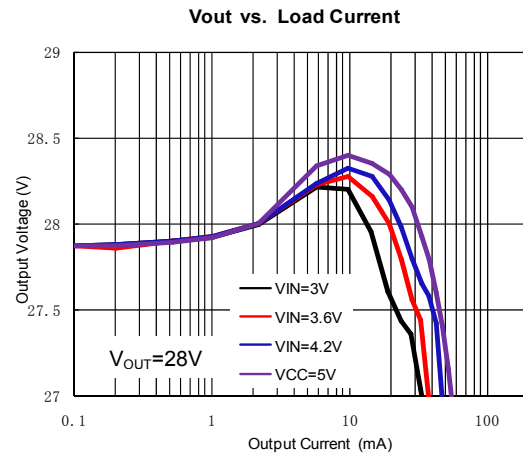
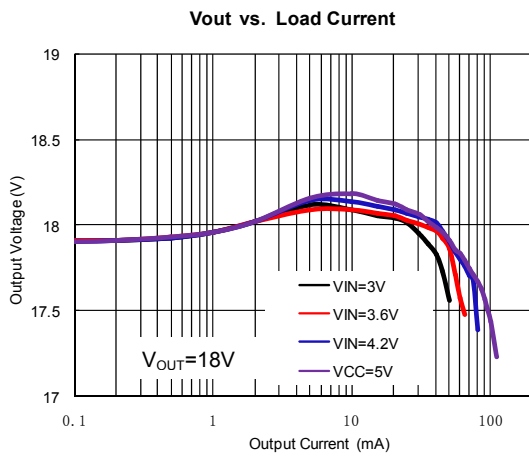
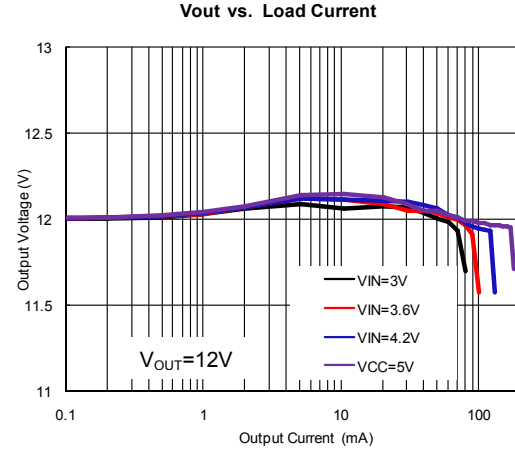
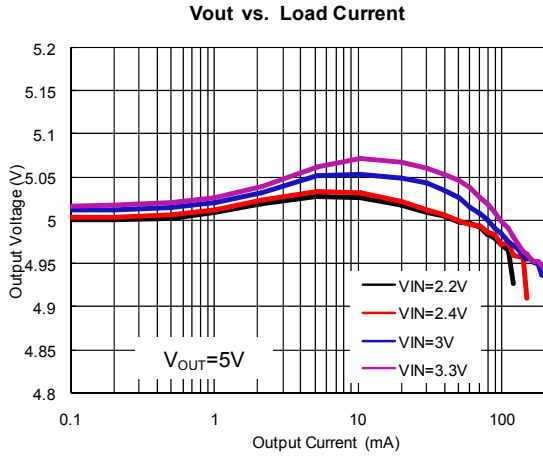
Typical Operating Characteristics

(C_{IN} , C_{OUT} , L refer to the Recommend Selection Table in page 6, $T_A=25^\circ\text{C}$, unless otherwise noted)



Typical Operating Characteristics (Continued)

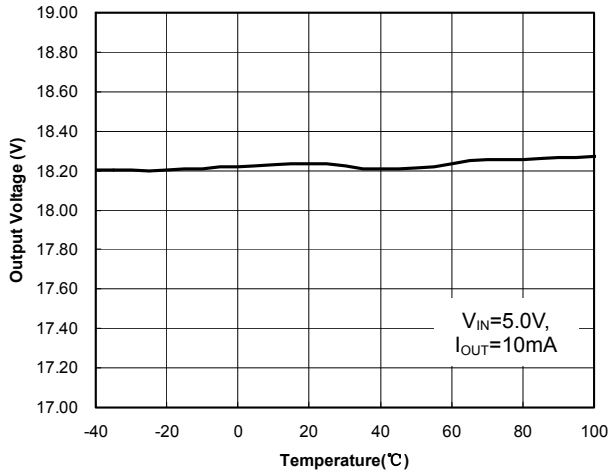
(C_{IN} , C_{OUT} , L refer to the Recommend Selection Table in page 6, $T_A=25^\circ\text{C}$, unless otherwise noted)



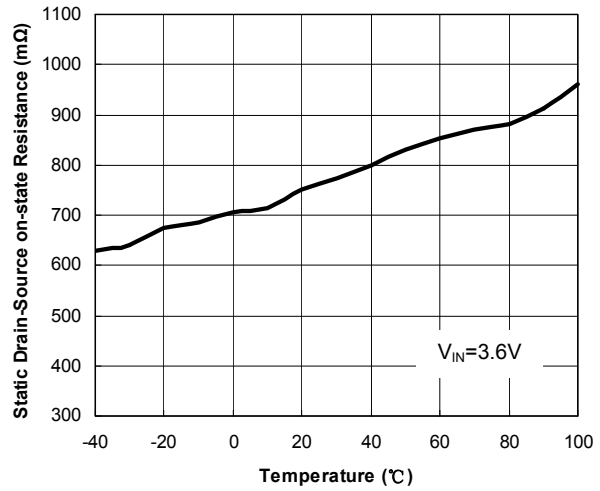
Typical Operating Characteristics (Continued)

(C_{IN} , C_{OUT} , L refer to the Recommend Selection Table in page 6 , $T_A=25^\circ\text{C}$, unless otherwise noted)

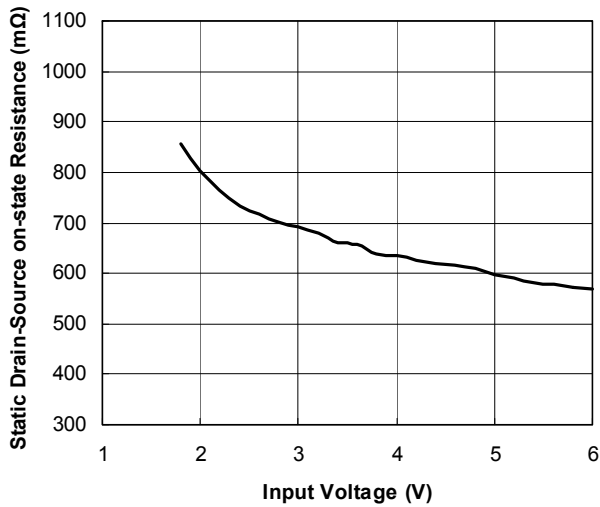
Output Voltage vs. Temperature



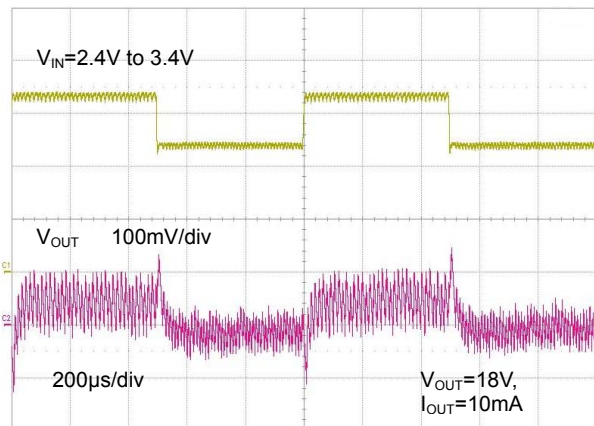
$R_{DS(ON)}$ vs. Temperature



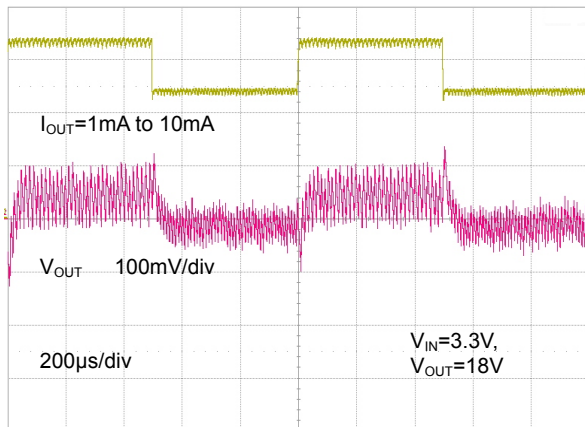
$R_{DS(ON)}$ vs. Input Voltage



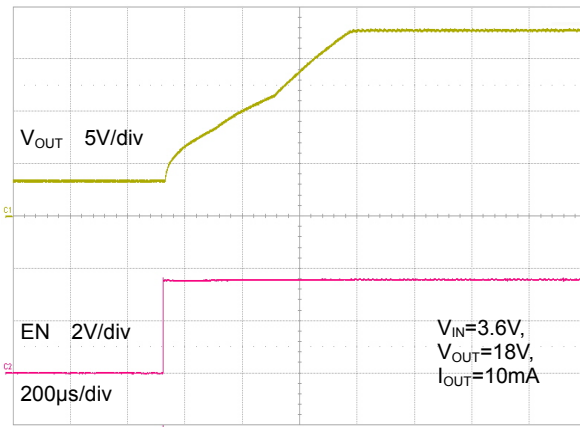
Line Transient Response



Load Transient Response



Start-up Behavior



Applications Information

Inductor Selection, Maximum Load Current

Since the PFM peak current control scheme is inherently stable, the inductor value does not affect the stability of the regulator. The selection of the inductor together with the nominal load current, input and output voltage of the application determines the switching frequency of the converter. Depending on the application, inductor values between 1 μ H up to 33 μ H are recommended. The maximum inductor value is determined by the maximum on time of the switch, typically 6 μ s. The peak current limit of 600mA (typically) should be reached within this 6 μ s period for proper operation.

The inductor value determines the maximum switching frequency of the converter. Therefore, select the inductor value that ensures the maximum switching frequency at the converter maximum load current is not exceeded. The maximum switching frequency is calculated by the following formula:

$$f_{s_{\max}} = \frac{V_{IN_{\min}} \times (V_{OUT} - V_{IN})}{I_p \times L \times V_{OUT}}$$

Where:

I_p = Peak current as described in the previous peak current control section

L = Selected inductor value

$V_{IN_{\min}}$ = The highest switching frequency occurs at the minimum input voltage.

If the selected inductor value does not exceed the maximum switching frequency of the converter, the next step is to calculate the switching frequency at the nominal load current using the following formula:

$$f_s(I_{LOAD}) = \frac{2 \times I_{LOAD} \times (V_{OUT} - V_{IN} + V_d)}{I_p^2 \times L}$$

Where:

I_p = Peak current as described in the previous peak current control section

L = Selected inductor value

I_{LOAD} = Nominal load current

V_d = Rectifier diode forward voltage (typically 0.3V)

A smaller inductor value gives a higher converter switching frequency, but lowers the efficiency. The inductor value has less effect on the maximum available load current and is only of secondary order. The best way to calculate the maximum available load current under certain operating conditions is to estimate the expected converter efficiency at the maximum load current. This number can be taken out of the efficiency graphs shown in page 6. The maximum load current can then be estimated as follows:

$$I_{LOAD_{\max}} = \eta \frac{I_p^2 \times L \times f_{s_{\max}}}{2 \times (V_{OUT} - V_{IN})}$$

Where:

I_p = Peak current as described in the previous peak current control section

L = Selected inductor value

$f_{s_{\max}}$ = Maximum switching frequency as calculated previously

η = Expected converter efficiency. Typically 70% to 85%

The maximum load current of the converter is the current at the operation point where the converter starts to enter the continuous conduction mode. Usually the converter should always operate in discontinuous conduction mode.

Last, the selected inductor should have a saturation current that meets the maximum peak current of the converter (as calculated in the peak current control section). Use the maximum value for I_{LIM} for this calculation.

Another important inductor parameter is the dc resistance. The lower the DC resistance is, the higher the efficiency of the converter will be.

Setting the Output Voltage

The output voltage is calculated as:

$$V_{OUT} = 1.233V \times \left(1 + \frac{R1}{R2}\right)$$

For battery powered applications a high impedance voltage divider should be used with a typical value for R2 of 200k Ω and a maximum value for R1 of 2.2M Ω . Smaller values might be used to reduce the noise sensitivity of the feedback pin.

A feedforward capacitor across the upper feedback resistor R1 is required to provide sufficient overdrive for the error comparator.

The lower the switching frequency of the converter, the larger the feedforward capacitor value required. A good starting point is to use a 10pF feedforward capacitor. As a first estimation, the required value for the feedforward capacitor at the operation point can also be calculated using the following formula:

$$C_{FF} = \frac{1}{2\pi \times \frac{f_s}{20} \times R1}$$

Where:

R1 = Upper resistor of voltage divider

f_s = Switching frequency of the converter at the nominal load current (See previous section for calculating the switching frequency)

C_{FF} = Choose a value that comes closest to the result of the calculation

The larger the feedforward capacitor is, the worse the line regulation of the device will be. Therefore, when concern for line regulation is paramount, the selected feedforward capacitor should be as small as possible.

Output Capacitor Selection

The output capacitor limits the output ripple and maintains the output voltage during large load transitions. Ceramic capacitors with X5R or X7R temperature characteristics are highly recommended due to their small size, low ESR, and small temperature coefficients. For most applications, a 2.2 μ F ceramic capacitor is sufficient. For low output voltage applications a reduction in output voltage ripple can be achieved by increasing the output capacitor up to 10 μ F.

Input Capacitor Selection

For good input voltage filtering, low ESR ceramic capacitors are recommended. A 10 μ F ceramic input capacitor is sufficient for most of the applications. For better input voltage filtering this value can be increased.

Diode Selection

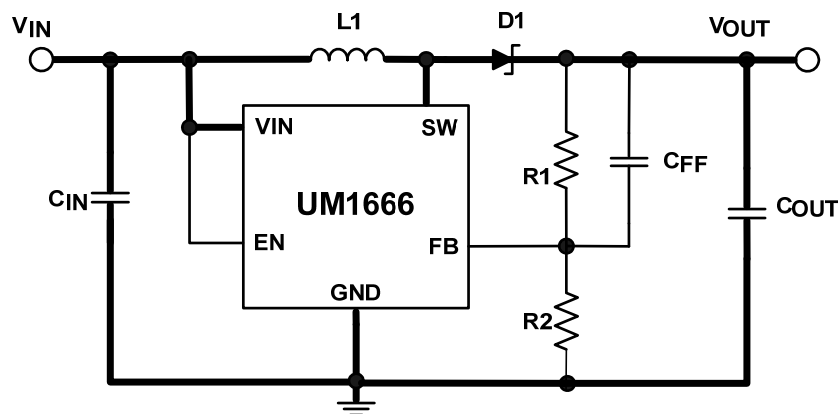
Schottky diode is a good choice for UM1666 because of its low forward voltage drop and fast

reverse recovery. Using Schottky diode can get better efficiency. The current rating of the diode should meet the peak current rating of the converter as it is calculated in the peak current control section. Use the maximum value for I_{LIM} for this calculation.

Layout Considerations

High switching frequencies and relatively large peak currents make the PCB layout a very important part of design. Good design minimizes excessive EMI on the feedback paths and voltage gradients in the ground plane, resulting in a stable and well-regulated output. Good layout for the UM1666 can be implemented by following a few simple design rules.

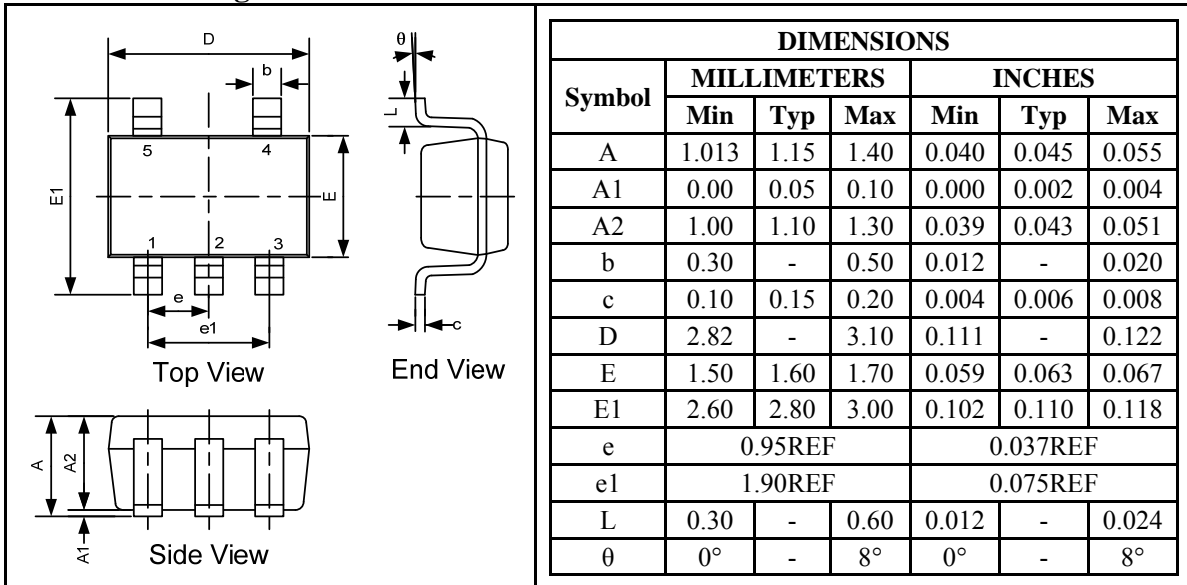
1. The input capacitor should be placed as close as possible to the input pin for good input voltage filtering.
2. The inductor and diode should be placed as close as possible to the switch pin to minimize the noise coupling into other circuits.
3. The feedback network should be routed away from the inductor. The feedback pin and feedback network should be shielded with a ground plane or trace to minimize noise coupling into this circuit.
4. Wide traces should be used for connections in bold as shown in the Figure below. A star ground connection or ground plane minimizes ground shifts and noise.



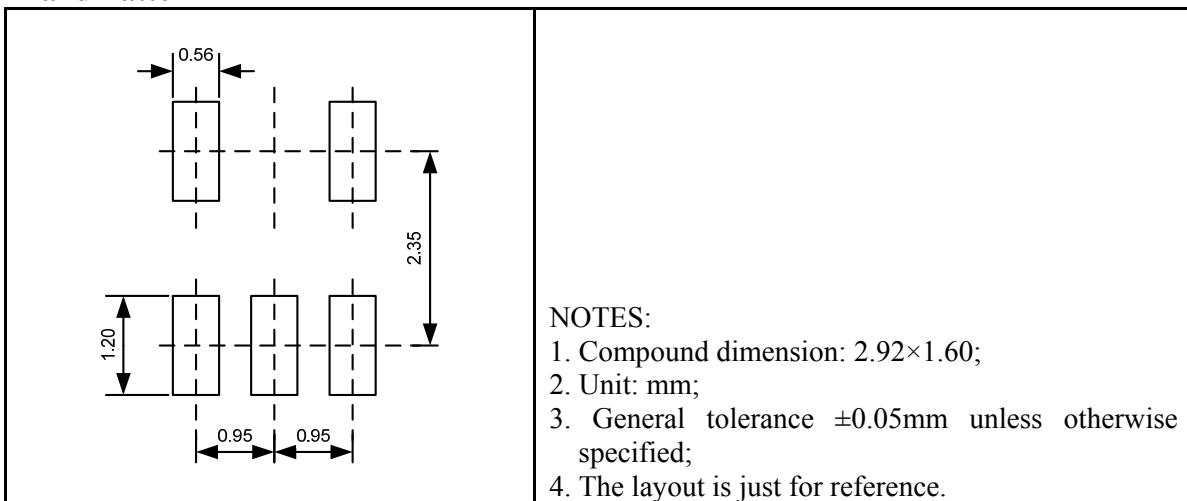
Package Information

UM1666S: SOT23-5

Outline Drawing



Land Pattern

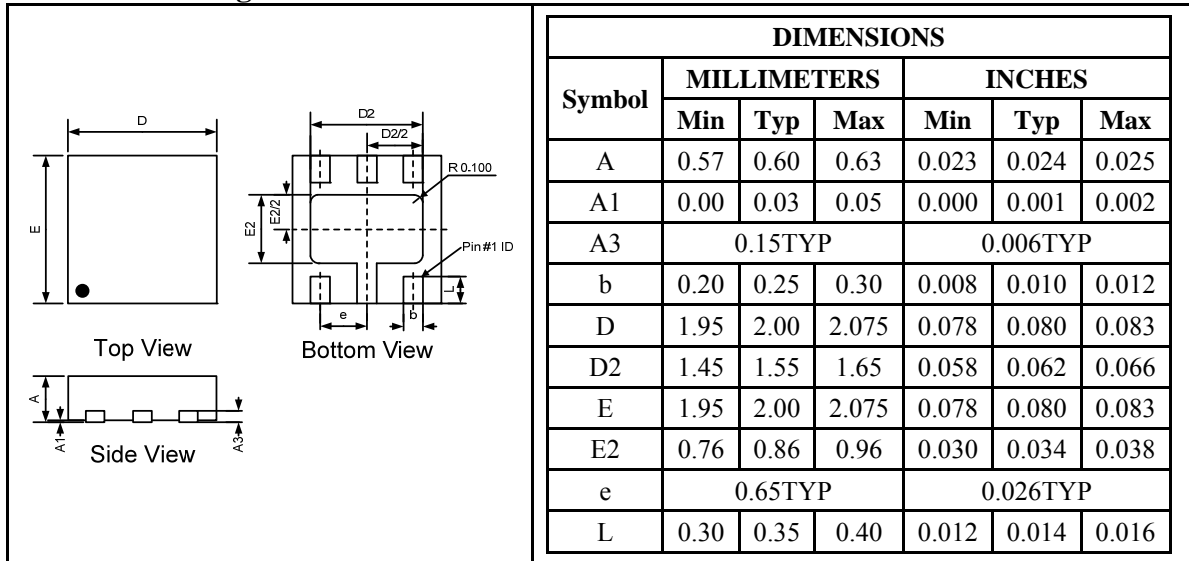


Tape and Reel Orientation

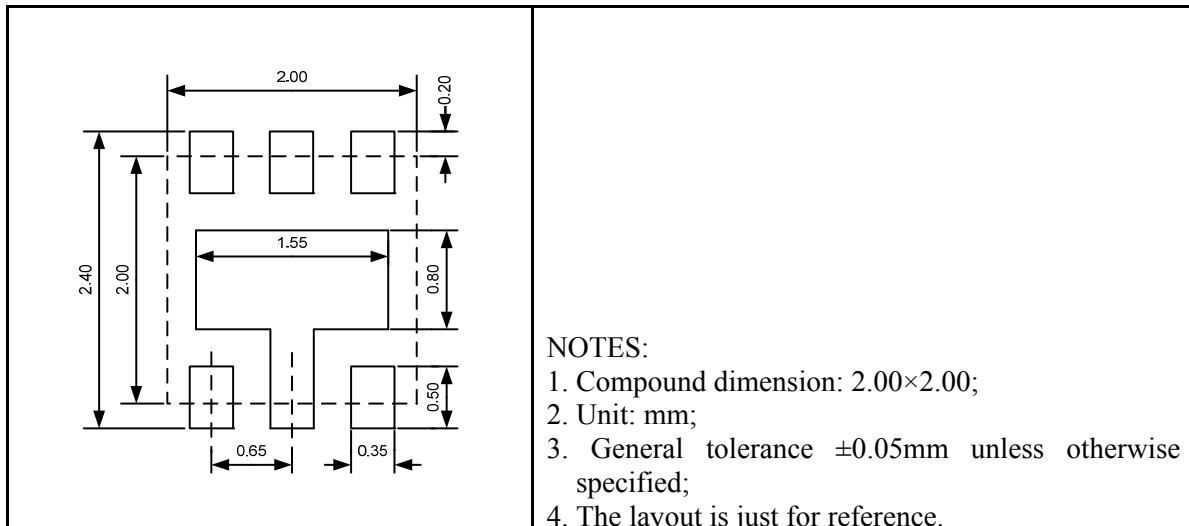


UM1666DA: DFN6L 2.0×2.0

Outline Drawing



Land Pattern



Tape and Reel Orientation



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